

TL77xxA Supply-Voltage Supervisors

1 Features

- Power-On Reset Generator
- Automatic Reset Generation After Voltage Drop
- Wide Supply-Voltage Range
- Precision Voltage Sensor
- Temperature-Compensated Voltage Reference
- Externally Adjustable Pulse Duration

2 Applications

- Computers
- Tablets
- Smart Phones
- Servers
- Music Players

3 Description

The TL77xxA family of integrated-circuit supply-voltage supervisors is designed specifically for use as reset controllers in microcomputer and microprocessor systems. The supply-voltage supervisor monitors the supply for undervoltage conditions at the SENSE input. During power up, the RESET output becomes active (low) when V_{CC} attains a value approaching 3.6 V. At this point (assuming that SENSE is above V_{IT+}), the delay timer function activates a time delay, after which outputs $\overline{\text{RESET}}$ and RESET go inactive (high and low, respectively). When an undervoltage condition occurs during normal operation, $\overline{\text{RESET}}$ and RESET go active.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)
TL77xxA	SOIC (8)	4.90 mm x 3.91 mm
	PDIP (8)	9.81 mm x 6.35 mm
TL7705A	SO (8)	6.20 mm x 5.30 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.

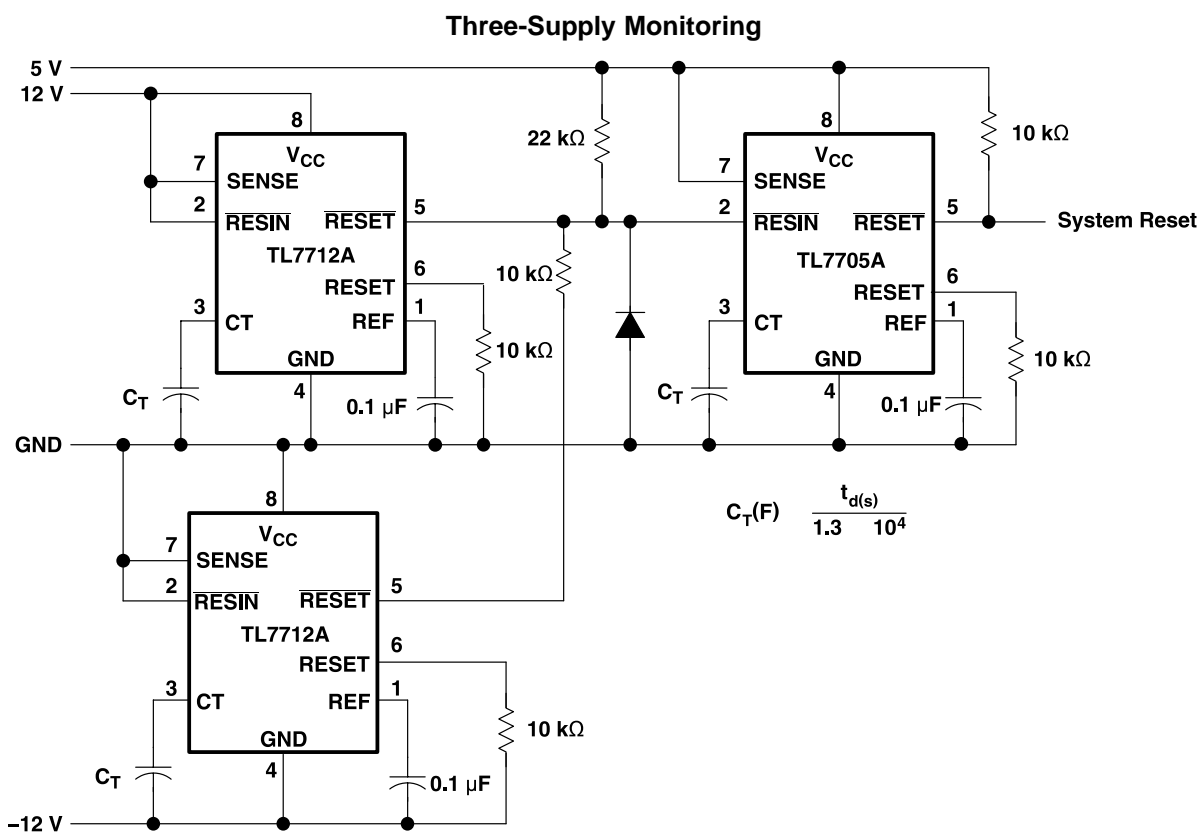


Table of Contents

1 Features	1	8.4 Device Functional Modes.....	9
2 Applications	1	9 Application and Implementation	10
3 Description	1	9.1 Application Information.....	10
4 Revision History	2	9.2 Typical Application	10
5 Pin Configuration and Functions	3	9.3 System Examples	12
6 Specifications	4	10 Power Supply Recommendations	14
6.1 Absolute Maximum Ratings	4	11 Layout	14
6.2 ESD Ratings.....	4	11.1 Layout Guidelines	14
6.3 Recommended Operating Conditions.....	4	11.2 Layout Example	14
6.4 Thermal Information	5	12 Device and Documentation Support	15
6.5 Electrical Characteristics.....	5	12.1 Related Links	15
6.6 Switching Characteristics	5	12.2 Receiving Notification of Documentation Updates	15
6.7 Typical Characteristics	6	12.3 Community Resources.....	15
7 Parameter Measurement Information	7	12.4 Trademarks	15
8 Detailed Description	8	12.5 Electrostatic Discharge Caution.....	15
8.1 Overview	8	12.6 Glossary	15
8.2 Functional Block Diagram	8	13 Mechanical, Packaging, and Orderable	15
8.3 Feature Description.....	9	Information	15

4 Revision History

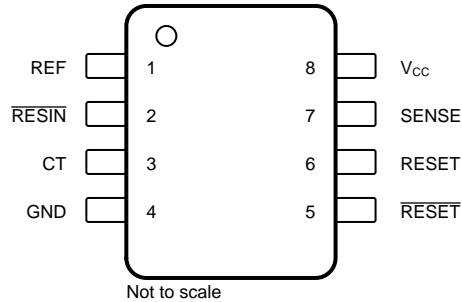
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision J (January 2015) to Revision K	Page
• Added SO (8) to <i>Device Information</i> table.....	1
• Changed RESET to $\overline{\text{RESET}}$ in <i>Timing Diagram</i>	6
• Added <i>Receiving Notification of Documentation Updates</i> section	15

Changes from Revision I (July 2009) to Revision J	Page
• Added <i>Applications</i> , <i>Device Information</i> table, <i>Pin Functions</i> table, <i>ESD Ratings</i> table, <i>Thermal Information</i> table, <i>Typical Characteristics</i> , <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section.	1
• Deleted <i>Ordering Information</i> table.	1

5 Pin Configuration and Functions

**TL7702A, TL7709A, TL77012A, TL7715A D or P Package
TL7705A D, P, or PS Package
8-Pin SOIC, PDIP, or SO
Top View**



Pin Functions

PIN		TYPE	DESCRIPTION
NAME	NO.		
CT	3	I/O	External timing-capacitor pin
GND	4	—	Device ground
REF	1	O	Voltage reference output
RESET	6	O	Supervisor reset signal output
$\overline{\text{RESET}}$	5	O	Supervisor reset signal output (inverted)
$\overline{\text{RESIN}}$	2	I	Reset input
SENSE	7	I	Sense input
V _{CC}	8	—	Power Supply

6 Specifications

6.1 Absolute Maximum Ratings

 over operating free-air temperature range (unless otherwise noted) ⁽¹⁾

		MIN	MAX	UNIT	
V _{CC}	Supply voltage ⁽²⁾		20	V	
V _I	Input voltage, $\overline{\text{RESIN}}$	-0.3	20	V	
V _I	Input voltage range SENSE	TL7702A ⁽³⁾	-0.3	6	V
		TL7705A	-0.3	20	V
		TL7709A	-0.3	20	V
		TL7712A, TL7715A	-0.3	20	V
I _{OH}	High-level output current, I _{OH} , $\overline{\text{RESET}}$		-30	mA	
I _{OL}	Low-level output current, I _{OL} , $\overline{\text{RESET}}$		30	mA	
T _J	Operating virtual junction temperature		150	°C	
T _{stg}	Storage temperature	-65	150	°C	

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) For proper operation of the TL7702A, the voltage applied to the SENSE terminal should not exceed V_{CC} - 1 V or 6 V, whichever is less.
- (3) All voltage values are with respect to GND.

6.2 ESD Ratings

		VALUE	UNIT
V _(ESD)	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	1000
		Charged device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	1000

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT	
V _{CC}	Supply Voltage	3.5	18	V	
V _{IH}	High-level input voltage at $\overline{\text{RESIN}}$	2		V	
V _{IL}	Low-level input voltage at $\overline{\text{RESIN}}$		0.6	V	
V _I	Input voltage, SENSE	TL7702A	0	See ⁽¹⁾	V
		TL7705A	0	10	
		TL7709A	0	15	
		TL7712A	0	20	
		TL7715A	0	20	
I _{OH}	High-level output current, $\overline{\text{RESET}}$		-16	mA	
I _{OL}	Low-level output current, $\overline{\text{RESET}}$		16	mA	
T _A	Operating free-air temperature	TL77xxAC	0	70	°C
		TL77xxAI	-40	85	

- (1) For proper operation of the TL7702A, the voltage applied to the SENSE terminal should not exceed V_{CC} - 1 V or 6 V, whichever is less.

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾	TL77xxA			UNIT
	D	P	PS	
	8 PINS	8 PINS	8 PINS	
R _{θJA} Junction-to-ambient thermal resistance	97	85	95	°C/W

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

6.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS ⁽¹⁾	TL77xxAC TL77xxAI			UNIT	
		MIN	TYP	MAX		
V _{OH} High-level output voltage, RESET	I _{OH} = -16 mA	V _{CC} - 1.5			V	
V _{OL} Low-level output voltage, RESET	I _{OL} = 16 mA	0.4			V	
V _{ref} Reference Voltage	T _A = 25°C	2.48	2.53	2.58	V	
V _{IT-} Negative-going input threshold voltage, SENSE	T _A = 25°C	TL7702A	2.48	2.53	2.58	V
		TL7705A	4.5	4.55	4.6	
		TL7709A	7.5	7.6	7.7	
		TL7712A	10.6	10.8	11	
		TL7715A	13.2	13.5	13.8	
V _{hys} Hysteresis, SENS (V _{IT+} - V _{IT-})	T _A = 25°C	TL7702A	10			mV
		TL7705A	15			
		TL7709A	20			
		TL7712A	35			
		TL7715A	45			
I _i Input current	RESIN	V _I = 2.4 V to V _{CC}		20	μA	
		V _I = 0.4 V		-100		
	SENSE TL7702A	V _{ref} < V _I < V _{CC} - 1.5 V		0.5		2
I _{OH} High-level output current, RESET	V _O = 18 V	50			μA	
I _{OL} Low-level output current, RESET	V _O = 0	-50			μA	
I _{CC} Supply current	All inputs and outputs open	1.8		3	mA	

(1) All electrical characteristics are measured with 0.1-μF capacitors connected at REF, CT, and V_{CC} to GND.

6.6 Switching Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS ⁽¹⁾	TL77xxAC TL77xxAI			UNIT
		MIN	TYP	MAX	
Output pulse duration	CT = 0.1 μF	0.65	1.2	2.6	msec
Input pulse duration at RESIN		0.4			μs
t _{w(S)} Pulse duration at sense input to switch outputs	V _{IH} = V _{IT-} + 200 mV, V _{IL} = V _{IT-} - 200 mV	2			μs
t _{pd} propagation delay time, RESIN to RESET	V _{CC} = 5V	1			μs
t _r Rise time	RESET	V _{CC} = 5 V ⁽²⁾			μs
	RESET				
t _f Fall time	RESET	V _{CC} = 5 V ⁽²⁾			μs
	RESET				

(1) All switching characteristics are measured with 0.1-μF capacitors connected at REF and V_{CC} to GND.

(2) The rise and fall times are measured with a 4.7-kΩ load resistor at RESET and RESET.

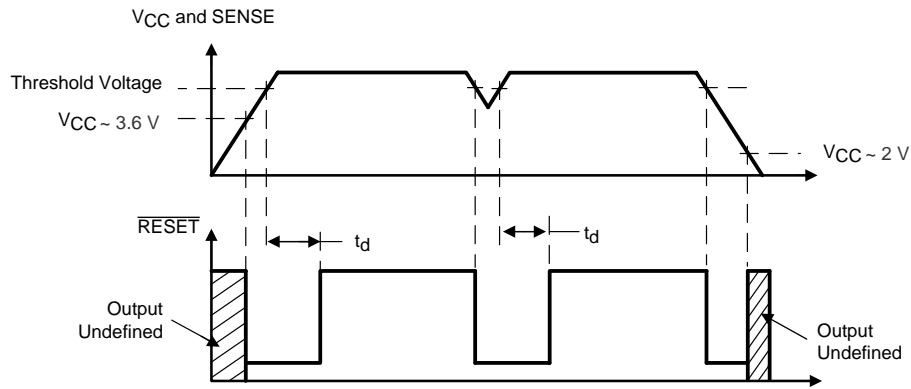


Figure 1. Timing Diagram

6.7 Typical Characteristics

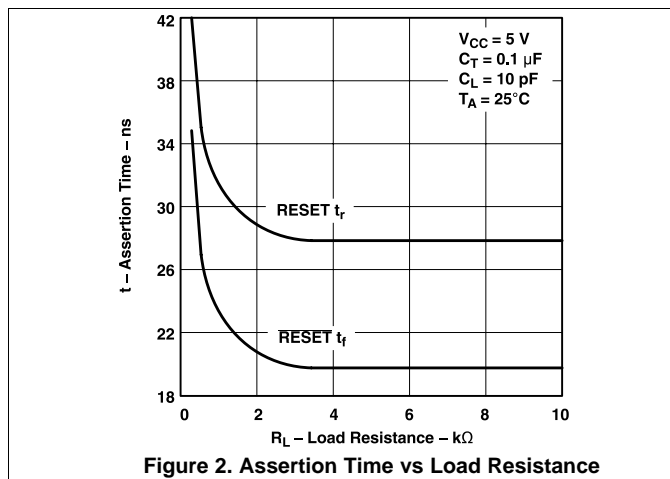


Figure 2. Assertion Time vs Load Resistance

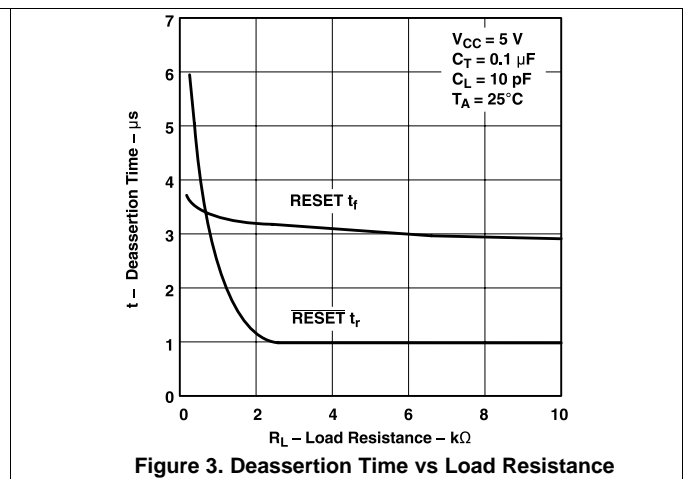


Figure 3. Deassertion Time vs Load Resistance

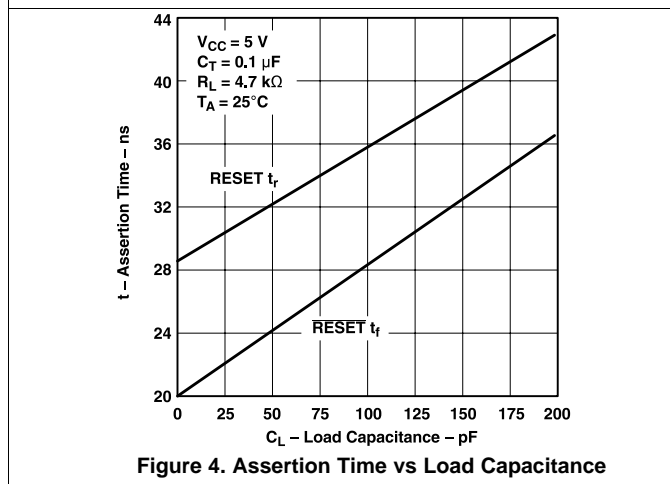


Figure 4. Assertion Time vs Load Capacitance

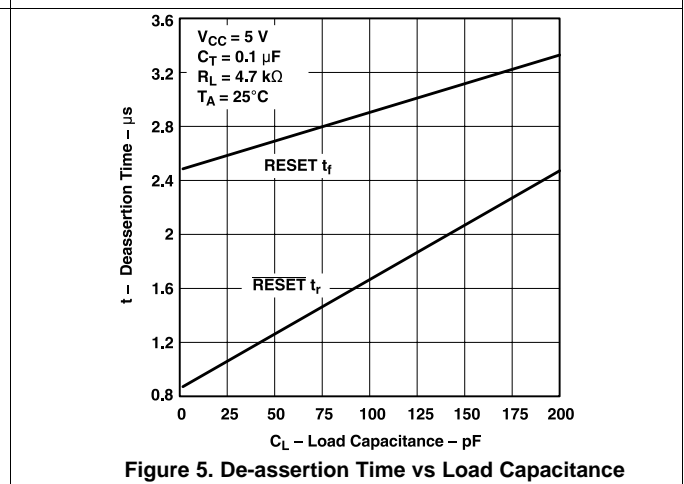


Figure 5. De-assertion Time vs Load Capacitance

7 Parameter Measurement Information

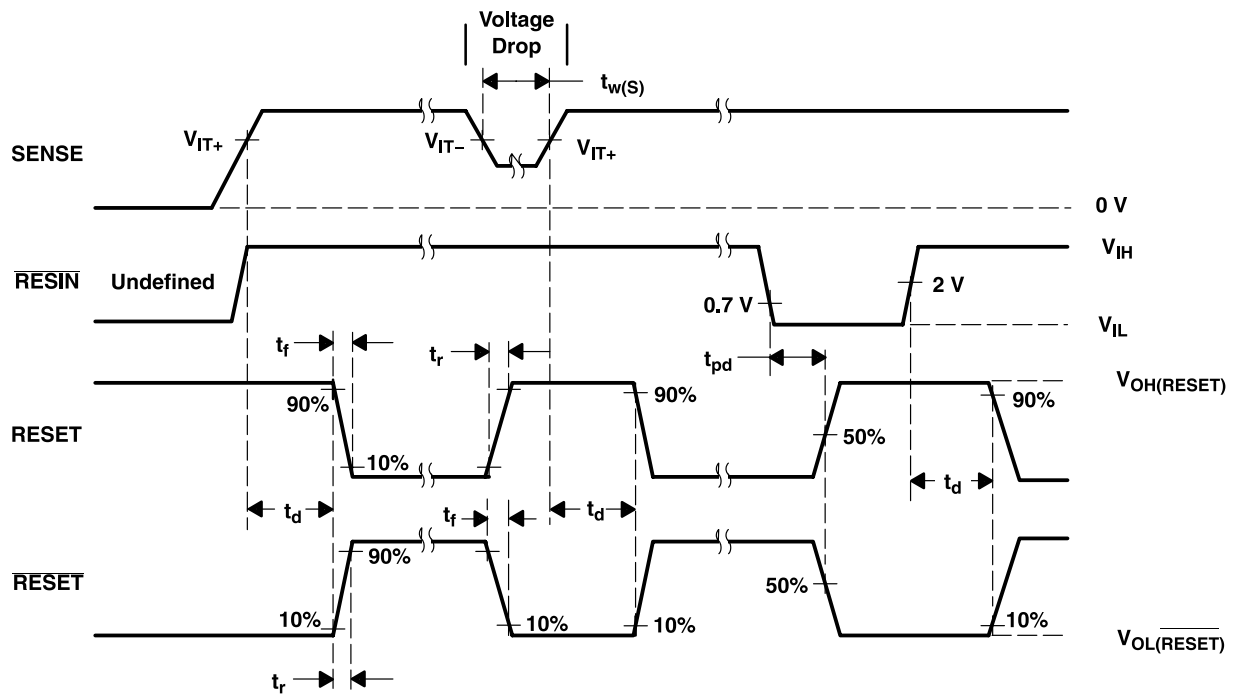


Figure 6. Voltage Waveform

8 Detailed Description

8.1 Overview

The TL77xxA family of integrated-circuit supply-voltage supervisors is designed specifically for use as reset controllers in microcomputer and microprocessor systems. The supply-voltage supervisor monitors the supply for undervoltage conditions at the SENSE input. During power up, the RESET output becomes active (low) when V_{CC} attains a value approaching 3.6 V. At this point (assuming that SENSE is above V_{IT+}), the delay timer function activates a time delay, after which outputs $\overline{\text{RESET}}$ and RESET go inactive (high and low, respectively). When an undervoltage condition occurs during normal operation, $\overline{\text{RESET}}$ and RESET go active. To ensure that a complete reset occurs, the reset outputs remain active for a time delay after the voltage at the SENSE input exceeds the positive-going threshold value.

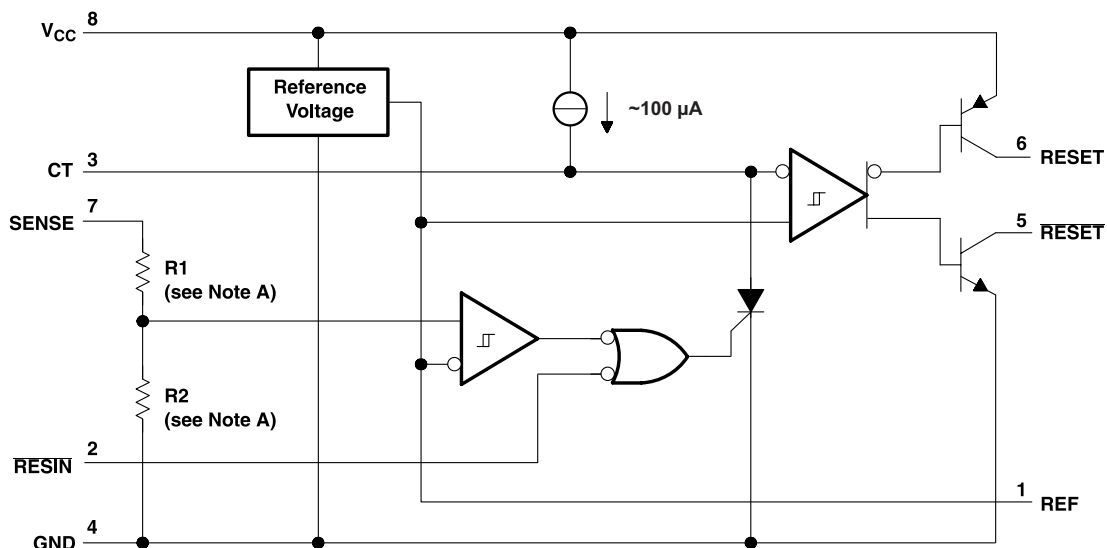
During power down and when SENSE is below V_{IT-} , the outputs remain active until V_{CC} falls below 2 V. After this, the outputs are undefined. An external capacitor (typically 0.1 μF) must be connected to REF to reduce the influence of fast transients in the supply voltage.

Five versions of this circuit are available:

- TL7705A ($V_t = 4.55 \text{ V}$): Application in TTL-systems and microcomputer systems which require a 5 volt supply (for example, TMS7000)
- TL7709A ($V_t = 7.6 \text{ V}$): Application in microcomputer systems using the TMS1XXXNLL
- TL7712A ($V_t = 10.8 \text{ V}$): Application in CMOS, microprocessor, and memory circuits with a 12 volt supply.
- TL7715A ($V_t = 13.5 \text{ V}$): Application in circuits which operate with a supply voltage of 15 V, as is found often in analog circuits.
- TL7702A ($V_t = 2.5 \text{ V}$): Application in systems where other supply voltages are used. The required trigger level may be adjusted with an external resistor divider at the SENSE input.

8.2 Functional Block Diagram

The functional block diagram is shown for illustrative purposes only; the actual circuit includes a trimming network to adjust the reference voltage and sense-comparator trip point.



- A. TL7702A: $R1 = 0 \Omega$, $R2 = \text{open}$
 TL7705A: $R1 = 7.8 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$
 TL7709A: $R1 = 19.7 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$
 TL7712A: $R1 = 32.7 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$
 TL7715A: $R1 = 43.4 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$
- B. Resistor values shown are nominal.

8.3 Feature Description

8.3.1 Wide Supply-Voltage Range

The TL77xxA family operates over a wide supply voltage range of 3.5 V to 18 V.

8.3.2 Externally Adjustable Pulse Duration

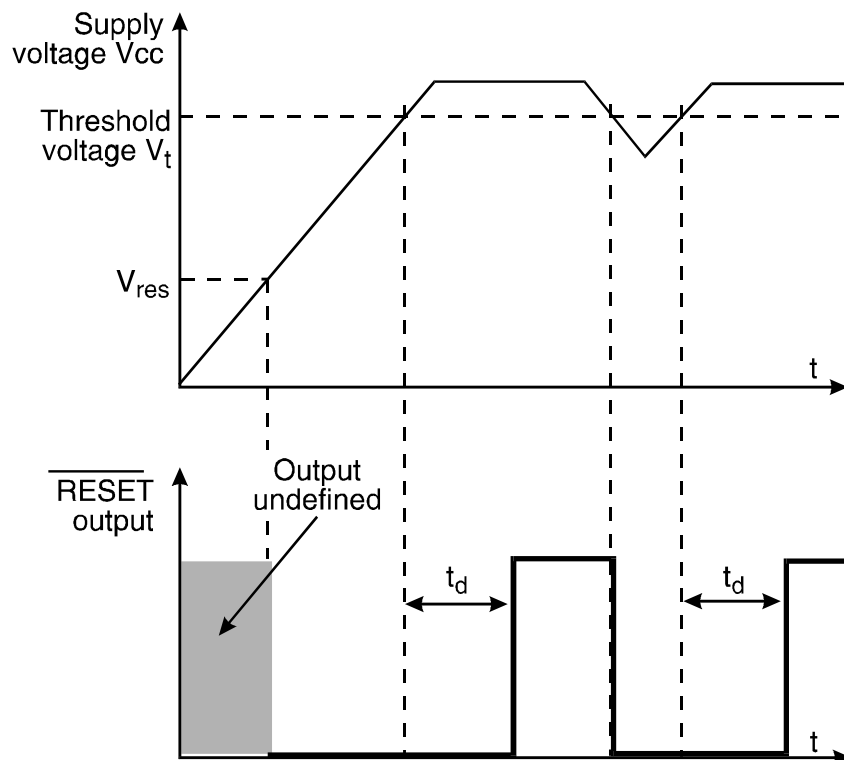
The time delay is determined by the value of the external capacitor C_T : $t_d = 1.3 \times 10^4 \times C_T$, where C_T is in farads (F) and t_d is in seconds (s).

8.3.3 Temperature-Compensated Voltage Reference

The series TL77xxA incorporates an extremely stable reference voltage source. This voltage source can also be used in applications where a constant voltage source is required. The reference voltage varies less than 10 mV over the supply voltage range of 3.5 V to 18 V. The same stability of the reference voltage is maintained, when the ambient temperature is changed. The reference's voltage varies only 16 mV when the ambient temperature is changed from -40°C to $+85^\circ\text{C}$.

8.4 Device Functional Modes

Figure 7 shows the timing of the various signals. In this example the SENSE input is connected to the supply voltage V_{CC} as in typical applications of this device. The minimum supply voltage for which the function of this device is guaranteed is 3.6 V. After power-on, the outputs are undefined until the minimum supply voltage V_{res} is reached. For the TL77xxA the minimum supply voltage is $V_{res} = 3\text{ V}$ (typical 2.5 V). Beyond the voltage V_{res} the capacitor C_T is first kept discharged, and the outputs stay in the active state (RESET = High, RESET = Low). When the input voltage becomes higher than the threshold voltage V_t , the thyristor is turned off and the capacitor is charged. After a delay, t_d , the voltage at the capacitor passes the trigger level of the output comparator and the outputs become inactive. The circuit to be initialized is now set to a defined state and starts the correct operation.



A. Note: SENSE Input connected to V_{CC}

Figure 7. Timing Diagram

9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

This application shows the initialization circuit diagrams for a microprocessor system with supply voltage $V_{CC} = 5$ V. The external components required are the decoupling capacitor C_{ref} for the reference voltage and the timing capacitor C_T . The outputs of the TL77xxA are open collector outputs. In [Figure 8](#) therefore a pull-up resistor is shown at the RESET output to ensure the correct HIGH level.

9.2 Typical Application

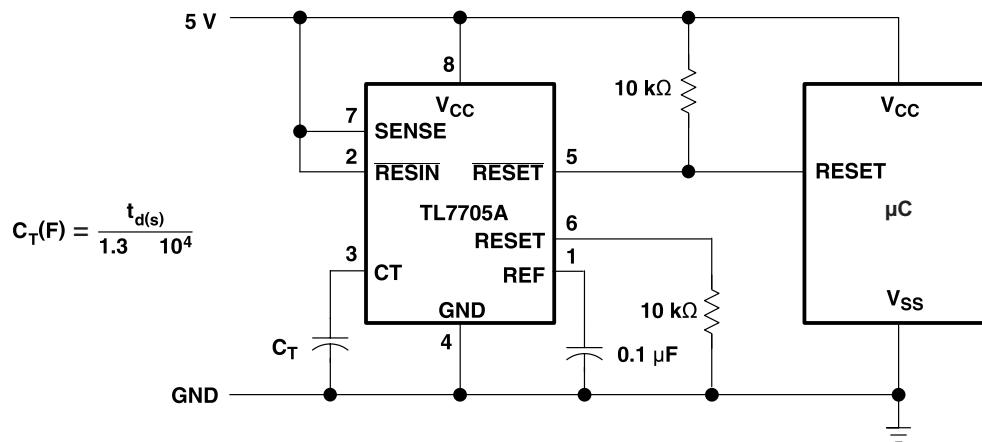


Figure 8. Reset Controller Schematic for a Microprocessor

9.2.1 Design Requirements

- 5-V microprocessor supply voltage
- $t_d = 1.3$ ms

9.2.2 Detailed Design Procedure

- Select reasonable values for pull-up/pull-down resistors for RESET and $\overline{\text{RESET}}$. This design uses 10 kΩ.
- Choose $C_T = 0.1$ µF to achieve $t_d = 1.3$ ms
- This design uses only the active-low reset output ($\overline{\text{RESET}}$) because the example microcontroller resets when the input is Low.

Typical Application (continued)

9.2.3 Application Curves

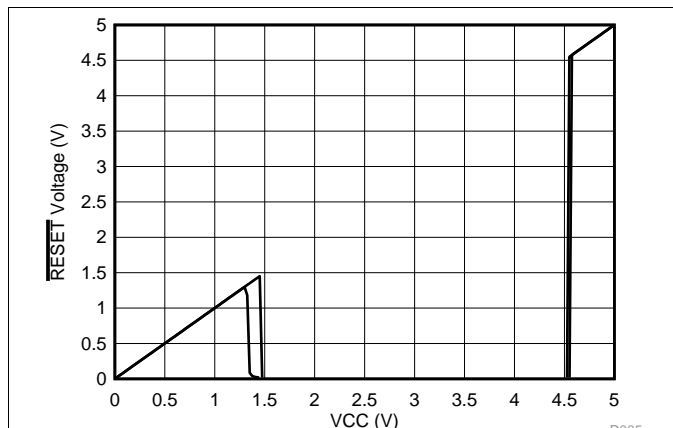


Figure 9. Supervisor $\overline{\text{RESET}}$ Output Voltage vs V_{CC}

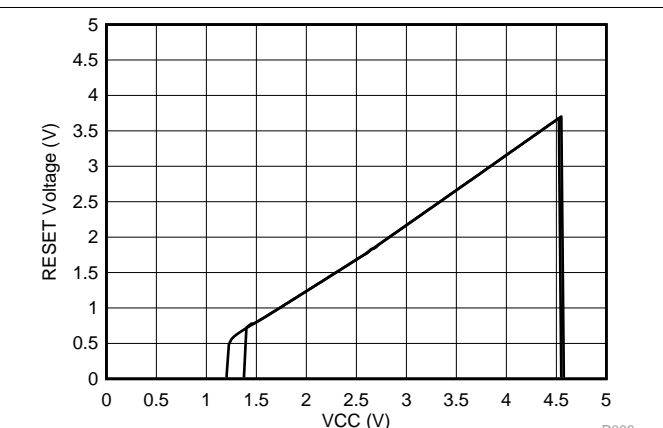


Figure 10. Supervisor RESET Output Voltage vs V_{CC}

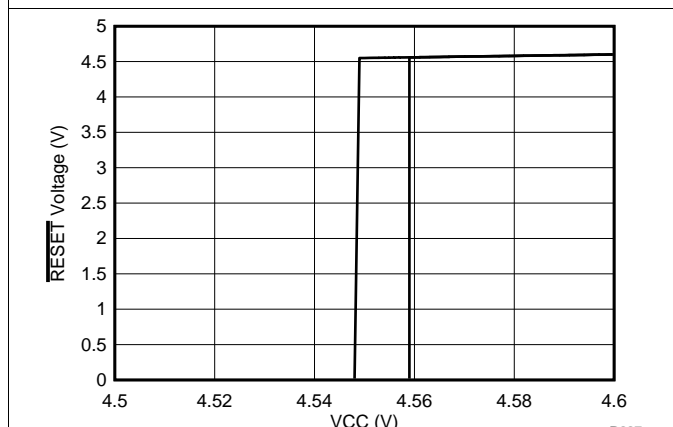


Figure 11. Supervisor $\overline{\text{RESET}}$ Output Voltage vs V_{CC} at Transition

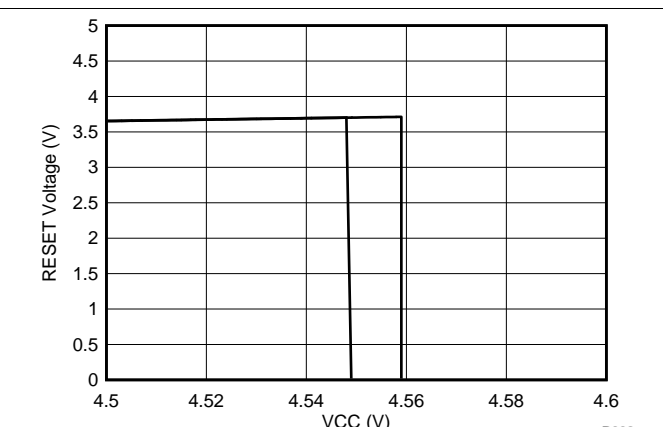


Figure 12. Supervisor RESET Output Voltage vs V_{CC} at Transition

9.3 System Examples

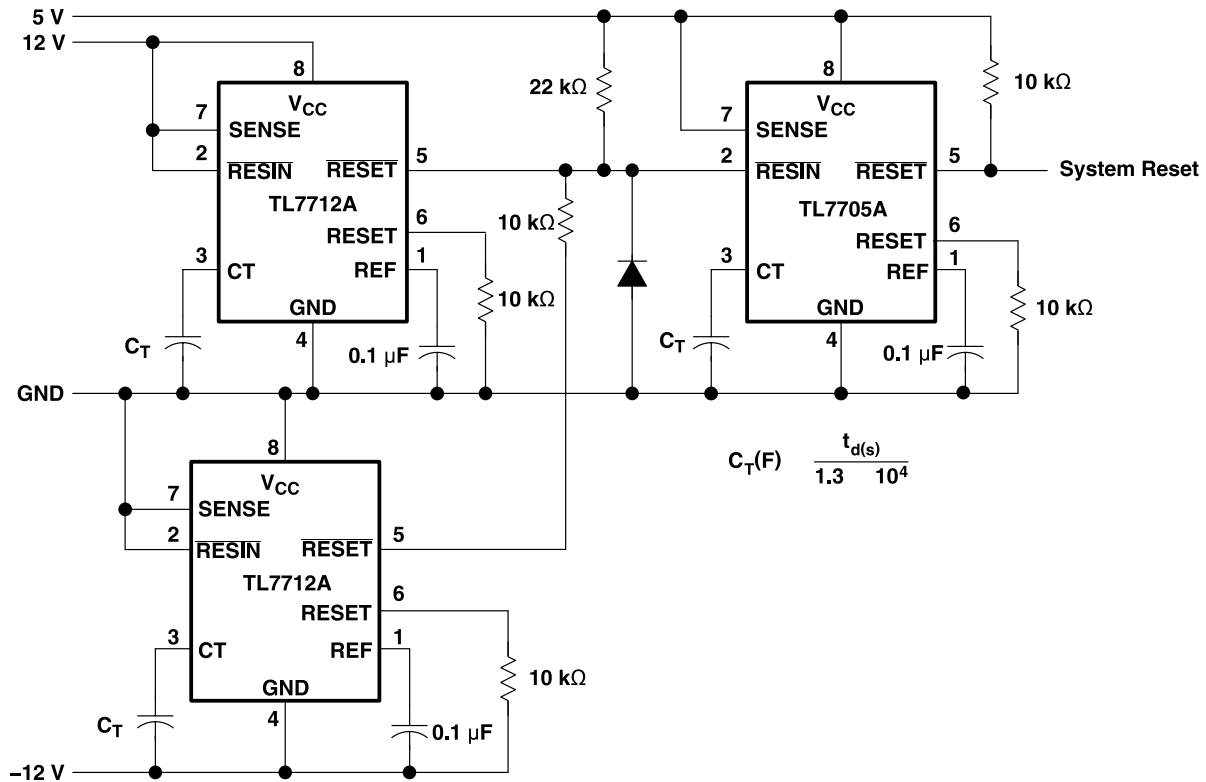


Figure 13. Multi Power-Supply System Reset Generation Schematic

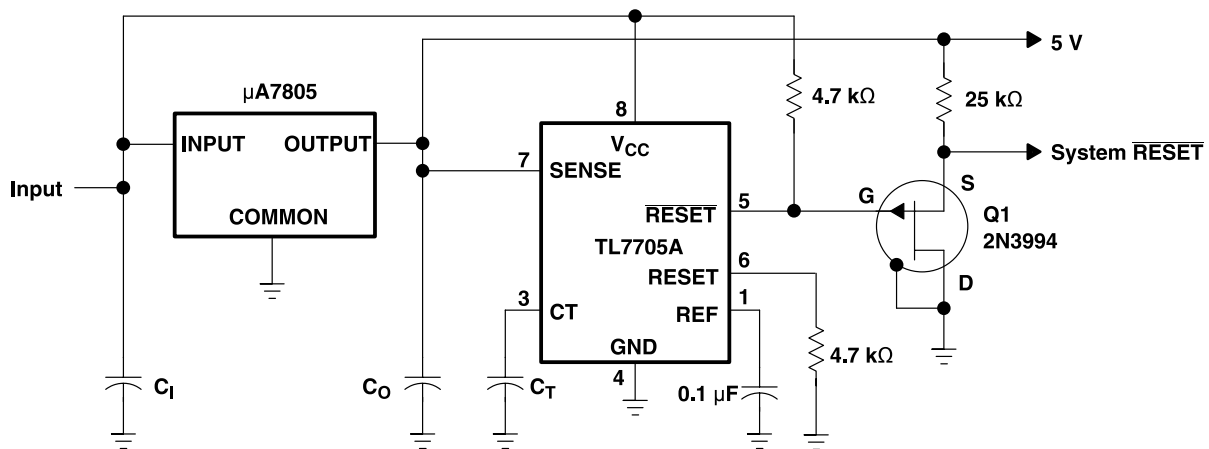


Figure 14. Eliminating Undefined States Using a P-Channel JFET Schematic

System Examples (continued)

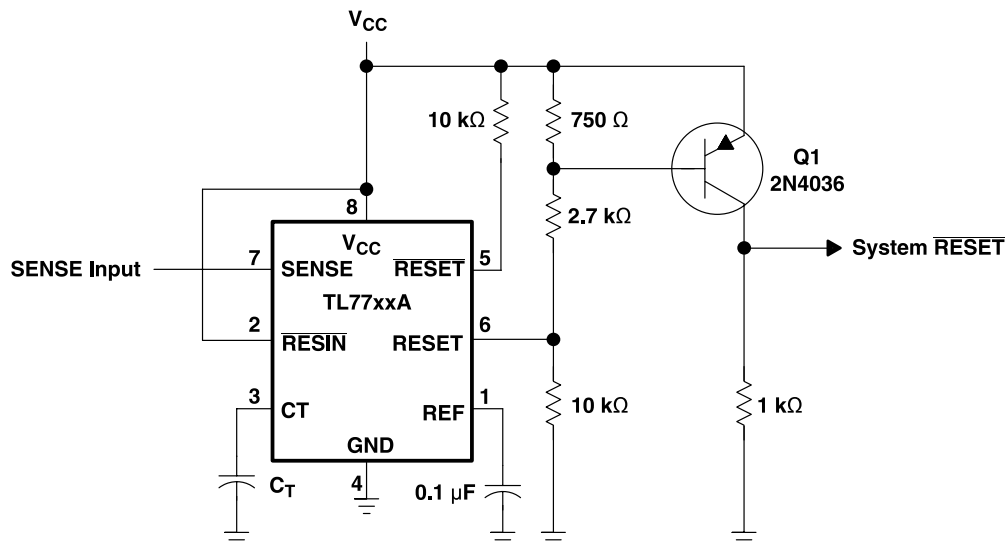


Figure 15. Eliminating Undefined States Using PNP Transistor Schematic

10 Power Supply Recommendations

The TL77xxA devices operate within the specifications from the [Recommended Operating Conditions](#) between 3.5 V and 18 V.

CAUTION

These devices risk being damaged when powered by more than 20 V.

11 Layout

11.1 Layout Guidelines

The voltage monitor should be placed on the printed circuit board, where there are no neighboring circuits in the which switch high currents (like bus interface circuits and power switches). When laying out the layout of the printed circuit board, take special care with the interconnects which carry analog signals. Beside the SENSE input these are the C_T and V_{ref} terminals. Noise coupled into the C_T input will lead to a reduction of the output pulse width. Noise coupled into the V_{ref} input or into the filter capacitor at this input may lead to undesired triggering of the circuit and by this to an undesired RESET pulse. Practice shows, that this malfunction when high currents flow over the interconnects of these capacitors to the GND terminal of the voltage monitor. To avoid these effects, the GND terminals of these capacitors must be connected by the shortest way to the GND terminal of the voltage monitor in so that no currents caused by other circuits flow over these wires. [Figure 16](#) show a layout proposal for the printed circuit board. Furthermore the resistors of the voltage divider at the SENSE input of the TL7702 (R2 and R3 in [Figure 16](#)) have to be placed in so, that no noise may be coupled into this circuit.

11.2 Layout Example

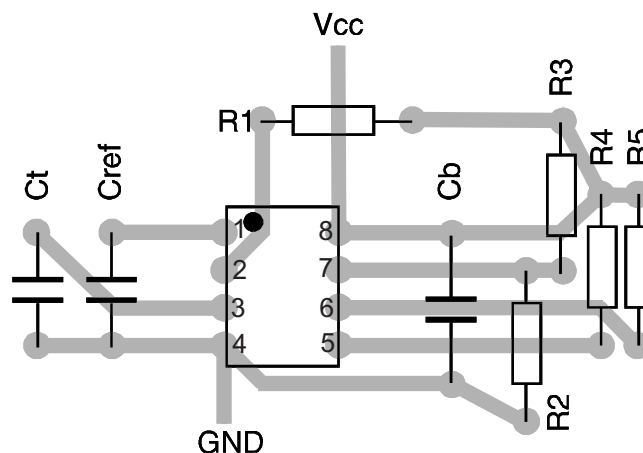


Figure 16. Printed Circuit Layout for the Supply Voltage Supervisor

12 Device and Documentation Support

12.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

Table 1. Related Links

PARTS	PRODUCT FOLDER	SAMPLE & BUY	TECHNICAL DOCUMENTS	TOOLS & SOFTWARE	SUPPORT & COMMUNITY
TL7702A	Click here	Click here	Click here	Click here	Click here
TL7705A	Click here	Click here	Click here	Click here	Click here
TL7709A	Click here	Click here	Click here	Click here	Click here
TL7712A	Click here	Click here	Click here	Click here	Click here
TL7715A	Click here	Click here	Click here	Click here	Click here

12.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.4 Trademarks

E2E is a trademark of Texas Instruments.
All other trademarks are the property of their respective owners.

12.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.6 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TL7702ACD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7702AC	Samples
TL7702ACDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7702AC	Samples
TL7702ACDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7702AC	Samples
TL7702ACDRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7702AC	Samples
TL7702ACDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7702AC	Samples
TL7702ACP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	TL7702ACP	Samples
TL7702AID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	7702AI	Samples
TL7702AIDE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	7702AI	Samples
TL7702AIDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	7702AI	Samples
TL7702AIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	7702AI	Samples
TL7702AIDRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	7702AI	Samples
TL7702AIDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	7702AI	Samples
TL7702AIP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	-40 to 85	TL7702AIP	Samples
TL7702AIPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	-40 to 85	TL7702AIP	Samples
TL7705ACD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7705AC	Samples
TL7705ACDE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7705AC	Samples
TL7705ACDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7705AC	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TL7705ACDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7705AC	Samples
TL7705ACDRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7705AC	Samples
TL7705ACDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7705AC	Samples
TL7705ACP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	TL7705ACP	Samples
TL7705ACPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	TL7705ACP	Samples
TL7705ACPSR	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	T7705A	Samples
TL7705AID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	7705AI	Samples
TL7705AIDE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	7705AI	Samples
TL7705AIDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	7705AI	Samples
TL7705AIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	7705AI	Samples
TL7705AIDRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	7705AI	Samples
TL7705AIDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	7705AI	Samples
TL7705AIP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	-40 to 85	TL7705AIP	Samples
TL7705AIPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	-40 to 85	TL7705AIP	Samples
TL7709ACD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7709AC	Samples
TL7709ACDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7709AC	Samples
TL7709ACDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7709AC	Samples
TL7709ACP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	TL7709ACP	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TL7709ACPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	TL7709ACP	Samples
TL7712ACD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7712AC	Samples
TL7712ACDE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7712AC	Samples
TL7712ACDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7712AC	Samples
TL7712ACDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7712AC	Samples
TL7712ACDRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7712AC	Samples
TL7712ACDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7712AC	Samples
TL7712ACP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	TL7712ACP	Samples
TL7712ACPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	TL7712ACP	Samples
TL7712AIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		7712AI	Samples
TL7715ACD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7715AC	Samples
TL7715ACDE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7715AC	Samples
TL7715ACDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7715AC	Samples
TL7715ACP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	TL7715ACP	Samples
TL7715ACPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	TL7715ACP	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL7702ACDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TL7702ACDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TL7702AIDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TL7705ACDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TL7705ACPSR	SO	PS	8	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1
TL7705AIDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TL7709ACDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TL7712ACDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TL7712AIDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL7702ACDR	SOIC	D	8	2500	340.5	338.1	20.6
TL7702ACDR	SOIC	D	8	2500	367.0	367.0	35.0
TL7702AIDR	SOIC	D	8	2500	340.5	338.1	20.6
TL7705ACDR	SOIC	D	8	2500	340.5	338.1	20.6
TL7705ACPSR	SO	PS	8	2000	367.0	367.0	38.0
TL7705AIDR	SOIC	D	8	2500	340.5	338.1	20.6
TL7709ACDR	SOIC	D	8	2500	340.5	338.1	20.6
TL7712ACDR	SOIC	D	8	2500	340.5	338.1	20.6
TL7712AIDR	SOIC	D	8	2500	340.5	338.1	20.6

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AA.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

MECHANICAL DATA

PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

PS (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Publication IPC-7351 is recommended for alternate designs.
 - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



4040082/E 04/2010

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001 variation BA.

IMPORTANT NOTICE FOR TI DESIGN INFORMATION AND RESOURCES

Texas Instruments Incorporated ("TI") technical, application or other design advice, services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using any particular TI Resource in any way, you (individually or, if you are acting on behalf of a company, your company) agree to use it solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources.

You understand and agree that you remain responsible for using your independent analysis, evaluation and judgment in designing your applications and that you have full and exclusive responsibility to assure the safety of your applications and compliance of your applications (and of all TI products used in or for your applications) with all applicable regulations, laws and other applicable requirements. You represent that, with respect to your applications, you have all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. You agree that prior to using or distributing any applications that include TI products, you will thoroughly test such applications and the functionality of such TI products as used in such applications. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

You are authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING TI RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY YOU AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

You agree to fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of your non-compliance with the terms and provisions of this Notice.

This Notice applies to TI Resources. Additional terms apply to the use and purchase of certain types of materials, TI products and services. These include; without limitation, TI's standard terms for semiconductor products (<http://www.ti.com/sc/docs/stdterms.htm>), [evaluation modules](#), and [samples](http://www.ti.com/sc/docs/sampterm.htm) (<http://www.ti.com/sc/docs/sampterm.htm>).

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2017, Texas Instruments Incorporated